

Data sheet Product ICK S R 32,5 x 40



Heatsinks and active heatsinks for processors>Pin heatsinks

Ø 32.5 x 40 mm, pin heatsinks round

Features

design:	round
way of fixation:	• therm. conductive foil • therm. cond. adhesive
socket:	universal
suitable for processor type:	universal
diameter:	32.5 mm
height:	40 mm
plate thickness:	3.5 mm
weight:	24.61 g
thermal resistance:	7.6 - 1.45 K/W
dissipation loss:	7.89 W
surface:	Al-natural

Technical Drawing

